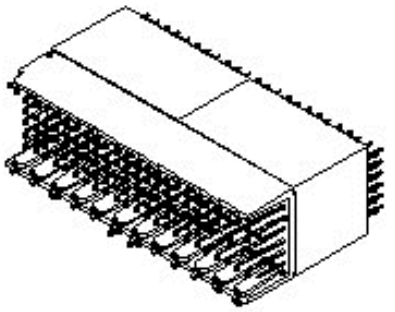
This document was generated on 05/25/2010

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: 0737691100
Status: Active
Overview: hdm
Description: 2.00mm (.079") Pitch HDM® Board-to-Board Stacking Header, High Rise Vertical, Press-Fit, Open End Option, 144 Circuits



Series image - Reference only

Documents:

- 3D Model
- Drawing (PDF)
- Product Specification PS-73780-999 (PDF)
- RoHS Certificate of Compliance (PDF)

Agency Certification

CSA	LR19980
UL	E29179

General

Product Family	Backplane Connectors
Series	73769
Application	Backplane, Mezzanine
Component Type	PCB Header
Overview	hdm
Product Name	HDM®
Style	N/A

Physical

Circuits (Loaded)	144
Circuits (maximum)	144
Color - Resin	Black
Durability (mating cycles max)	200
First Mate / Last Break	No
Flammability	94V-0
Guide to Mating Part	No
Keying to Mating Part	None
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin-Lead
Material - Resin	High Temperature Thermoplastic
Number of Columns	24
Number of Pairs	Open Pin Field
Number of Rows	6
Orientation	Vertical
PC Tail Length (in)	0.138 In
PC Tail Length (mm)	3.50 mm
PCB Retention	None
PCB Thickness Recommended (in)	0.055 In
PCB Thickness Recommended (mm)	1.40 mm
Packaging Type	Tube
Pitch - Mating Interface (in)	0.079 In
Pitch - Mating Interface (mm)	2.00 mm
Plating min: Mating (µin)	30
Plating min: Mating (µm)	0.75
Plating min: Termination (µin)	15
Plating min: Termination (µm)	0.375
Polarized to PCB	No
Stackable	Yes
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C

EU RoHS
RoHS Compliant by Exemption
REACH SVHC
Contains SVHC: No
Halogen-Free Status
Halogen-Free

China RoHS
50
Pb

Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, click here

Please visit the Contact Us section for any non-product compliance questions.

Search Parts in this Series
73769Series

Mates With
73632 HDM PLUS® Board-to-Board Daughtercard Receptacle. 73780 HDM® Board-to-Board Daughtercard Receptacle

Application Tooling | **FAQ**
Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description	Product #
Flat Rock Tooling for Pneumatic Press	0622013700
HDM® Backplane Insertion Head for 144 Positions	0622005703

Termination Interface: Style	Through Hole - Compliant Pin

Electrical

Current - Maximum per Contact	1A
Data Rate	1.0 Gbps
Real Signals (per 25mm)	72
Voltage - Maximum	100V AC

Material Info

Reference - Drawing Numbers

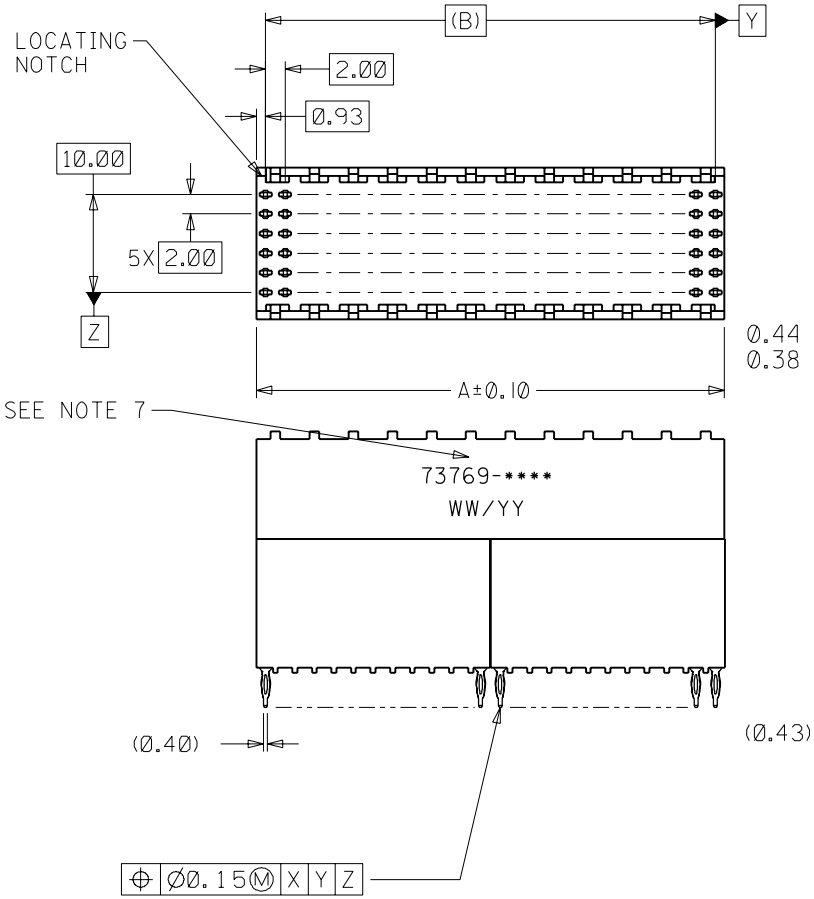
Packaging Specification	PK-70873-0870
Product Specification	PS-73780-999

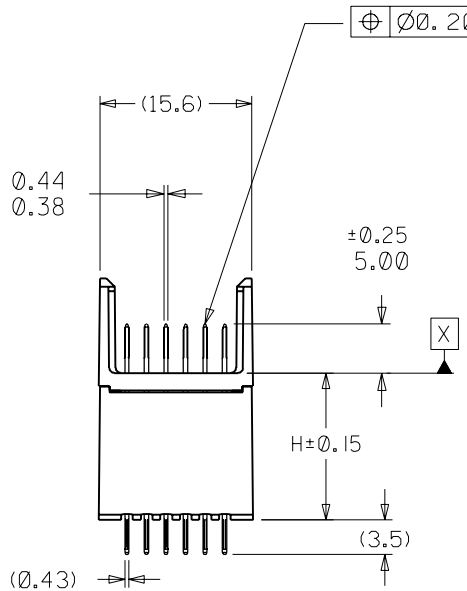
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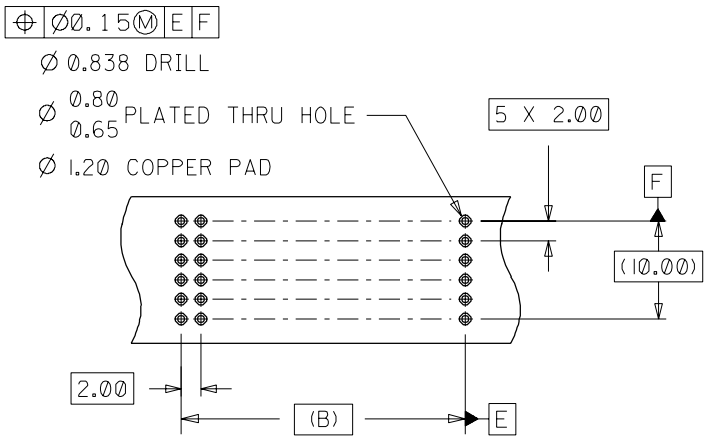
NOTES:

1. MATERIALS: HOUSING-LIQUID CRYSTAL POLYMER (LCP), GLASS-FILLED, UL94V-0, COLOR: BLACK. TERMINAL-PHOSPHOR BRONZE
2. FINISH: SELECTIVE GOLD (Au) IN CONTACT AREA, 0.00076mm MINIMUM THICKNESS; SELECTIVE TIN/LEAD (Sn/Pb) ON TAILS, NICKEL (Ni) OVERALL.
3. THIS PART CONFORMS TO MOLEX PRODUCT SPECIFICATION PS-73780-999.
4. DIMENSIONS ARE IN MILLIMETERS.
5. RECOMMENDED PCB THICKNESS: 2.50 MINIMUM.
6. PACKAGE PER PK-70873-0870, PK-70873-0871, OR PK-70873-0875.
7. PARTS MARKED WITH PART NUMBER AND DATE CODE APPROXIMATELY WHERE SHOWN.

ASSEMBLY P/N	TOTAL NUMBER OF SIGNAL CONTACTS	DIM "A"	DIM "B"	DIM "H"
73769-0100	72	23.84	22.00	15.05
73769-0200	72	23.84	22.00	6.05
73769-0300	72	23.84	22.00	10.05
73769-1100	144	47.84	46.00	15.05
73769-1200	144	47.84	46.00	6.05
73769-1300	144	47.84	46.00	10.05







BACKPLANE HOLE PATTERN

REVISED
EC NO: UDT20000-1073
DRWN: BINGHAM 00/05/08
CH'K: REED 00/05/08
APPR: BIXLER 00/05/08
DESCRIPTION
REV

QUALITY SYMBOLS
MAJOR ▼ = Ø
CRITICAL Ⓒ = Ø

GENERAL TOLERANCES: (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	±Ø.	±.
3 PLACES	±Ø.	±.
2 PLACES	±0.05	±.
1 PLACE	±0.10	±.
ANGULAR: ± 1/2°		

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

SCALE 2:1
DESIGN UNITS ☒ mm ☐ INCH
THIRD ANGLE PROJECTION
DIMENSIONS: ☐ mm/INCH ☐ INCH/mm ☒ mm ONLY
SHT REV
REVISE ON CAD ONLY

DRAWN BY & DATE: JBINGHAM 97/03/07
CHECKED BY & DATE: SREED 97/03/07
APPROVED BY & DATE: CBIXLER 97/03/07
CAD FILENAME: S73769X1.DGN

TITLE: SALES ASSEMBLY
HDM BACKPLANE STACKING MODULE
OPEN END OPTION PRESSFIT

molex MOLEX INCORPORATED

MATERIAL NO.: SEE CHART
DRAWING NO.: SD-73769-001
SHEET NO.: 1 OF 1
SIZE: B

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